

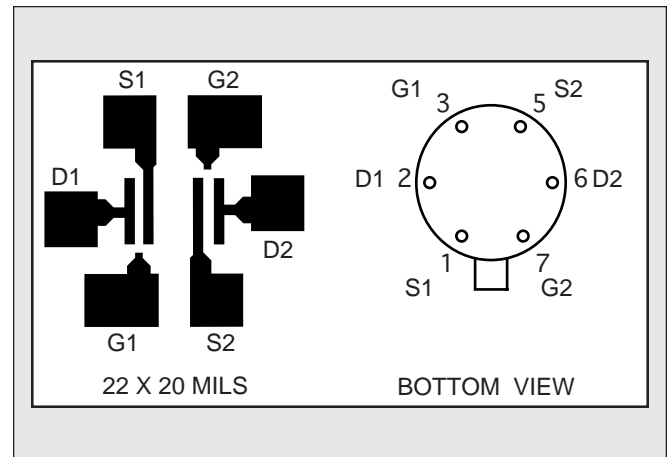
LINEAR SYSTEMS

Linear Integrated Systems

FEATURES		
LOW DRIFT	$ \Delta V_{GS1-2}/\Delta T = 5\mu V/^{\circ}C$ max.	
ULTRA LOW LEAKAGE	$I_G = 150fA$ TYP.	
LOW PINCHOFF	$V_P = 2V$ TYP.	
ABSOLUTE MAXIMUM RATINGS NOTE 1		
@ 25°C (unless otherwise noted)		
Maximum Temperatures		
Storage Temperature	-65° to +150°C	
Operating Junction Temperature	+150°C	
Maximum Voltage and Current for Each Transistor NOTE 1		
-V _{GSS}	Gate Voltage to Drain or Source	40V
-V _{DSO}	Drain to Source Voltage	40V
-I _{G(f)}	Gate Forward Current	10mA
-I _G	Gate Reverse Current	10μA
Maximum Power Dissipation		
Device Dissipation @ Free Air - Total		40mW @ +125°C

LS5905 LS5906 LS5907 LS5908 LS5909

LOW LEAKAGE LOW DRIFT
MONOLITHIC DUAL N-CANNEL JFET

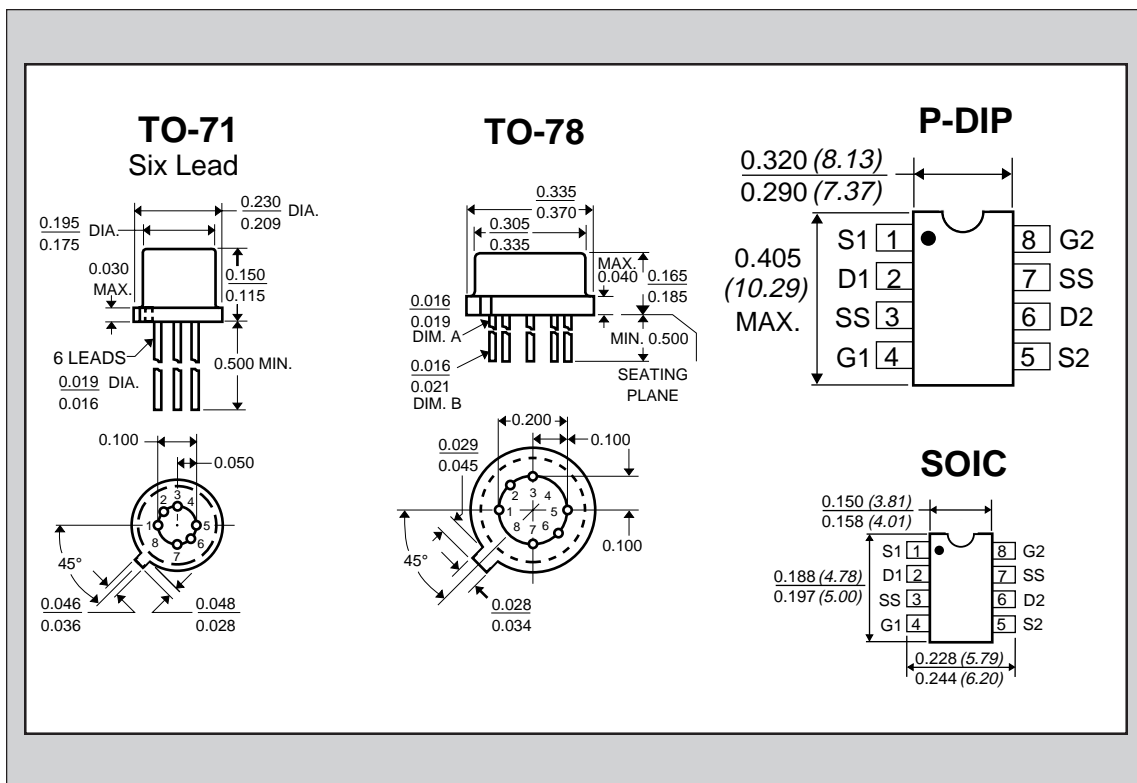


ELECTRICAL CHARACTERISTICS @ 25°C (unless otherwise noted)

SYMBOL	CHARACTERISTICS	LS5906	LS5907	LS5908	LS5909	LS5905	UNITS	CONDITIONS
$ \Delta V_{GS1-2}/\Delta T $ max.	Drift vs. Temperature	5	10	20	40	40	$\mu V/^{\circ}C$	$V_{DG} = 10V, I_D = 30\mu A$ $T_A = -55^{\circ}C$ to $+125^{\circ}C$
$ V_{GS1-2} $ max.	Offset Voltage	5	5	10	15	15	mV	$V_{DG} = 10V, I_D = 30\mu A$
-I _G max.	Operating	1	1	1	1	3	pA	
-I _G max.	High Temperature	1	1	1	1	3	nA	$T_A = +125^{\circ}C$
-I _{GSS} max.	At Full Conduction	2	2	2	2	5	pA	$V_{DS} = 0V, V_{GS} = 20V$
-I _{GSS} max.	High Temperature	5	5	5	5	10	nA	$T_A = +125^{\circ}C$

SYMBOL	CHARACTERISTICS	MIN.	TYP.	MAX.	UNITS	CONDITIONS
BV _{GSS}	Breakdown Voltage	40	60	--	V	$V_{DS} = 0, I_D = 1nA$
BV _{GGO}	Gate-to-Gate Breakdown	40	--	--	V	$I_G = 1nA, I_D = 0, I_S = 0$
TRANSCONDUCTANCE						
Y _{fss}	Full Conduction	70	300	500	μmho	$V_{DG} = 10V, V_{GS} = 0, f = 1kHz$
Y _{fs}	Typical Operation	50	100	200	μmho	$V_{DG} = 10V, I_D = 30\mu A, f = 1kHz$
$ Y_{fs1-2}/Y_{fs} $	Mismatch	--	1	5	%	
DRAIN CURRENT						
I _{DSS}	Full Conduction	60	400	1000	μA	$V_{DG} = 10V, V_{GS} = 0$
$ I_{DSS1-2}/I_{DSS} $	Mismatch at Full Conduction	--	2	5	%	
GATE VOLTAGE						
V _{GS(off)} or V _P	Pinchoff Voltage	0.6	2	4.5	V	$V_{DS} = 10V, I_D = 1nA$
V _{GS}	Operating Range	--	--	4	V	$V_{DS} = 10V, I_D = 30\mu A$
GATE CURRENT						
I _{GGO}	Gate-to-Gate Leakage	--	1	--	pA	$V_{GG} = 20V$

SYMBOL	CHARACTERISTICS	MIN.	TYP.	MAX.	UNITS	CONDITIONS
OUTPUT CONDUCTANCE						
Y_{OSS}	Full Conduction	--	--	5	μmho	$V_{DS} = 10\text{V}$ $V_{GS} = 0$
Y_{OS}	Operating	--	0.1	0.1	μmho	$V_{DS} = 10\text{V}$ $I_D = 30\mu\text{A}$
$ Y_{OS1-2} $	Differential	--	0.01	0.1	μmho	
COMMON MODE REJECTION						
CMR	$-20 \log \Delta V_{GS1-2} / \Delta V_{DS} $	--	90	--	dB	$\Delta V_{DS} = 10 \text{ to } 20\text{V}$ $I_D = 30\mu\text{A}$
CMR	$-20 \log \Delta V_{GS1-2} / \Delta V_{DS} $	--	90	--	dB	$\Delta V_{DS} = 5 \text{ to } 10\text{V}$ $I_D = 30\mu\text{A}$
NOISE						
NF	Figure	--	--	1	dB	$V_{DS} = 10\text{V}$ $V_{GS} = 0$ $R_G = 10\text{M}\Omega$ $f = 100\text{Hz}$ $\text{NBW} = 6\text{Hz}$
e_n	Voltage	--	20	70	$\text{nV}/\sqrt{\text{Hz}}$	$V_{DS} = 10\text{V}$ $I_D = 30\mu\text{A}$ $f = 10\text{Hz}$ $\text{NBW} = 1\text{Hz}$
CAPACITANCE						
C_{ISS}	Input	--	--	3	pF	$V_{DS} = 10\text{V}$ $V_{GS} = 0$ $f = 1\text{MHz}$
C_{RSS}	Reverse Transfer	--	--	1.5	pF	$V_{DS} = 10\text{V}$ $V_{GS} = 0$ $f = 1\text{MHz}$
C_{DD}	Drain-to-Drain	--	--	0.1	pF	$V_{DG} = 20\text{V}$ $I_D = 30\mu\text{A}$



NOTES:

1. These ratings are limiting values above which the serviceability of any semiconductor may be impaired.